Form PTO-1595 (Rev. 09/ 04) OMB No. 0851-0027 (exp. 6/30/2005)	U.S. DEPARTMENT OF COMMERC United States Patent and Trademark Office
RECORDATION FO	RM COVER SHEET
PATENT	'S ONLY
To the Director of the U.S. Patent and Trademark Office: Pleas	se record the attached documents or the new address(es) below.
Name of conveying party(les)/Execution Date(s): KENICHIRO ARIDOME (10/5/2006) AND SHINYA KANO (10/5/2006)	Name and address of receiving party(les)
	Name: SONY CORPORATION Internal Address:
Execution Date(s): In parentheses after inventor name Additional name(s) of conveying party(ies) attached? Yes X No	Street Address:
3. Nature of Conveyance: X Assignment Merger	7-35, Kitashinagawa 6-chome
Security Agreement Change of Name Government Interest Assignment	City: Shinagawa-ku, Tokyo State:
Executive Order 9424, Confirmatory License Other	Country: Japan Zip: 141-0001 Additional name(s) & address(es) Yes X No
4. Application or patent number(s): A. Patent Application No.(s) 11/489,970	This document is being filed together with a new application. B. Patent No.(s)
Additional numbers attached	
 Name and address to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved:
Name: Dennis M. Smid, Eşq. LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.:	Authorized to be charged by credit card
Street Address: 600 South Avenue West	Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)
City: Westfield	8. Payment Information
State: NJ Zip: 07090	a. Credit Card Last 4 Numbers
Phone Number: (908) 518-6374 Fax Number: (908) 654-0415	Expiration Date
Email Address: dsmid@ldikm.com	b. Deposit Account Number 12-1095 Authorized User Name Dennis M. Smid, Esq.
Signature:	November 9, 2006
Signature	Date Date
Dennis M. Smid, Esq 34,930 Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:

PATENT 708573_1.DOC

REEL: 018514 FRAME: 0264

2 003

ASSIGNMENT

Docket Number : SONYJP 3.0-623 Sony Ref. No.:S06P0864US00

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

IMAGE PROCESSING APPARATUS, IMAGE PROCESSING METHOD, AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors assigns, and legal representatives, my entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries forcign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in forcign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto:

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale,

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 11/489,970, Filing Date: July 20, 2006.

This assignment executed on the dates indicated below.

PATENT REEL: 018514 FRAME: 0265

former PTO/SB/15 (05/01)

Docket Number: SONYJP 3.0-623 Sony Ref No.: S06P0864US00	
	Kenichiro Aridome
Execution Date of U.S. Patent Application	Name of First or Sole Inventor
	Kanagawa Japan
	Residence of First or Sole Inventor
1)-+ Lan + 20-(Vanish and Andrew
October 5, 2006 1/4: 0 Date of this Assignment	Signature of First or Sole Inventor
	Shinya Kano
Execution Date of U.S. Patent Application	Name of Second Joint Inventor
	Chiba, Japan
	Residence of Second Joint Inventor
October 5, 2006	Singra Kana
Date of this Assignment	Singu Kana Signature of Second Joint Inventor
Execution Date of U.S. Patent Application	Jame of Third Joint Inventor
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Date of this Assignment	ignature of Third Joint Inventor
Execution Date of U.S. Patent Application	ame of Fourth Joint Inventor
	esidence of Fourth Joint Inventor
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